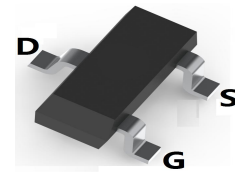
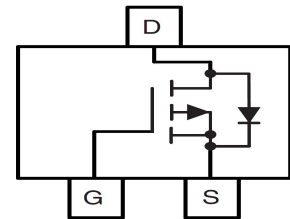


**P-Channel Power MOSFET**
**FEATURES**

- $V_{DS} = -20V, R_{DS(ON)} \leq 65m\Omega @ V_{GS} = -4.5V, I_D = -3.7A$
- Ultra Low On-Resistance
- P-Channel MOSFET
- Fast Switching


**SOT-23**

**MECHANICAL DATA**

- Case: SOT-23
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Weight: 0.008 grams (approximate)

**Absolute Maximum Ratings**

|                          | Parameter                                  | Max.         | Units      |
|--------------------------|--|--------------|------------|
| $V_{DS}$                 | Drain- Source Voltage                      | -20          | V          |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | -3.7         | A          |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | -2.2         |            |
| $I_{DM}$                 | Pulsed Drain Current ①                     | -22          |            |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation                          | 1.3          | W          |
| $P_D @ T_A = 70^\circ C$ | Power Dissipation                          | 0.8          |            |
|                          | Linear Derating Factor                     | 0.01         |            |
| $E_{AS}$                 | Single Pulse Avalanche Energy④             | 11           | mJ         |
| $V_{GS}$                 | Gate-to-Source Voltage                     | $\pm 12$     | V          |
| $T_J, T_{STG}$           | Junction and Storage Temperature Range     | -55 to + 150 | $^\circ C$ |

**Thermal Resistance**

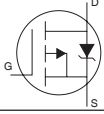
|                 | Parameter                    | Typ. | Max. | Units        |
|-----------------|------------------------------|------|------|--------------|
| $R_{\theta JA}$ | Maximum Junction-to-Ambient③ | 75   | 100  | $^\circ C/W$ |

**Electrical Characteristics @  $T_J = 25^\circ C$  (unless otherwise specified)**

|                                 | Parameter                            | Min.  | Typ.   | Max.  | Units        | Conditions                                     |
|---------------------------------|--------------------------------------|-------|--------|-------|--------------|--|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | -20   | —      | —     | V            | $V_{GS} = 0V, I_D = -250\mu A$                 |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —     | -0.009 | —     | $V/^\circ C$ | Reference to $25^\circ C, I_D = -1mA$ ②        |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —     | 0.050  | 0.065 | $\Omega$     | $V_{GS} = -4.5V, I_D = -3.7A$ ②                |
|                                 |                                      | —     | 0.080  | 0.135 |              | $V_{GS} = -2.5V, I_D = -3.1A$ ②                |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | -0.40 | -0.55  | -1.2  | V            | $V_{DS} = V_{GS}, I_D = -250\mu A$             |
| $g_{fs}$                        | Forward Transconductance             | 6.0   | —      | —     | S            | $V_{DS} = -10V, I_D = -3.7A$ ②                 |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —     | —      | -1.0  | $\mu A$      | $V_{DS} = -20V, V_{GS} = 0V$                   |
|                                 |                                      | —     | —      | -25   |              | $V_{DS} = -20V, V_{GS} = 0V, T_J = 70^\circ C$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —     | —      | -100  | nA           | $V_{GS} = -12V$                                |
|                                 | Gate-to-Source Reverse Leakage       | —     | —      | 100   |              | $V_{GS} = 12V$                                 |
| $Q_g$                           | Total Gate Charge                    | —     | 8.0    | 12    | nC           | $I_D = -3.7A$                                  |
| $Q_{gs}$                        | Gate-to-Source Charge                | —     | 1.2    | 1.8   |              | $V_{DS} = -10V$                                |
| $Q_{gd}$                        | Gate-to-Drain ("Miller") Charge      | —     | 2.8    | 4.2   |              | $V_{GS} = -5.0V$ ②                             |
| $t_{d(on)}$                     | Turn-On Delay Time                   | —     | 350    | —     | ns           | $V_{DD} = -10V$                                |
| $t_r$                           | Rise Time                            | —     | 48     | —     |              | $I_D = -3.7A$                                  |
| $t_{d(off)}$                    | Turn-Off Delay Time                  | —     | 588    | —     |              | $R_G = 89\Omega$                               |
| $t_f$                           | Fall Time                            | —     | 381    | —     |              | $R_D = 2.7\Omega$                              |
| $C_{iss}$                       | Input Capacitance                    | —     | 633    | —     | pF           | $V_{GS} = 0V$                                  |
| $C_{oss}$                       | Output Capacitance                   | —     | 145    | —     |              | $V_{DS} = -10V$                                |
| $C_{rss}$                       | Reverse Transfer Capacitance         | —     | 110    | —     |              | $f = 1.0MHz$                                   |

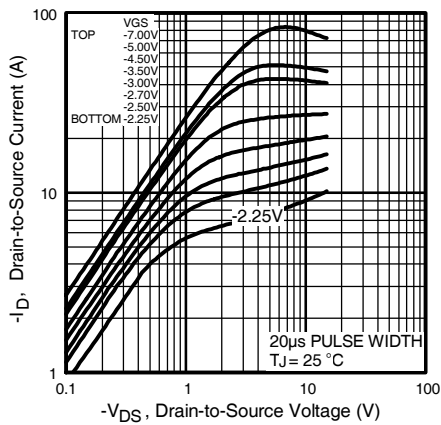
# IRLML6402

## Source-Drain Ratings and Characteristics

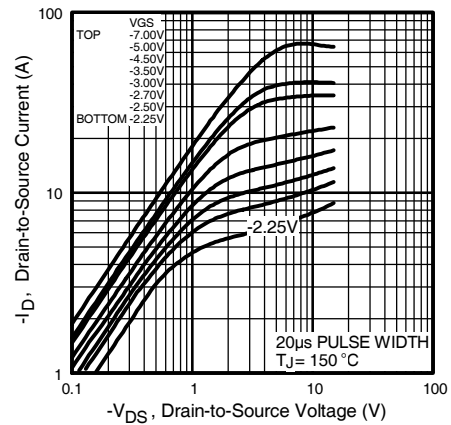
|          | Parameter                              | Min. | Typ. | Max. | Units | Conditions   |
|----------|--|------|------|------|-------|--|
| $I_S$    | Continuous Source Current (Body Diode) | —    | —    | -1.3 | A     | MOSFET symbol showing the integral reverse p-n junction diode.  |
| $I_{SM}$ | Pulsed Source Current (Body Diode) ①   | —    | —    | -22  |       |  |
| $V_{SD}$ | Diode Forward Voltage                  | —    | —    | -1.2 | V     | $T_J = 25^\circ\text{C}$ , $I_S = -1.0\text{A}$ , $V_{GS} = 0\text{V}$ ②   |
| $t_{rr}$ | Reverse Recovery Time                  | —    | 29   | 43   | ns    | $T_J = 25^\circ\text{C}$ , $I_F = -1.0\text{A}$  |
| $Q_{rr}$ | Reverse Recovery Charge                | —    | 11   | 17   | nC    | $di/dt = -100\text{A}/\mu\text{s}$ ②   |

**Notes:**

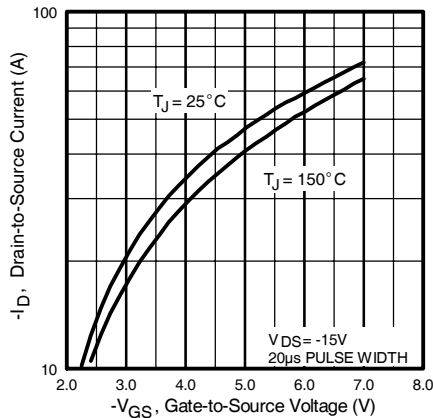
- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ③ Surface mounted on 1" square single layer 1oz. copper FR4 board, steady state.
- ④ Starting  $T_J = 25^\circ\text{C}$ ,  $L = 1.65\text{mH}$   
 $R_G = 25\Omega$ ,  $I_{AS} = -3.7\text{A}$ .



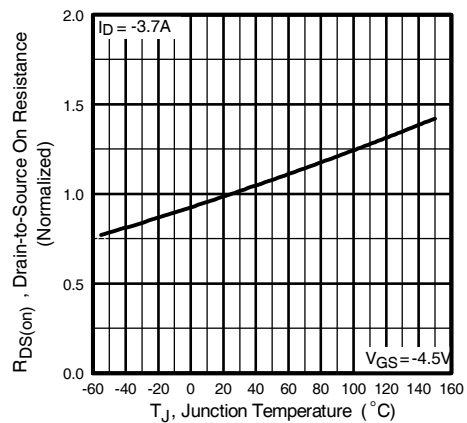
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics

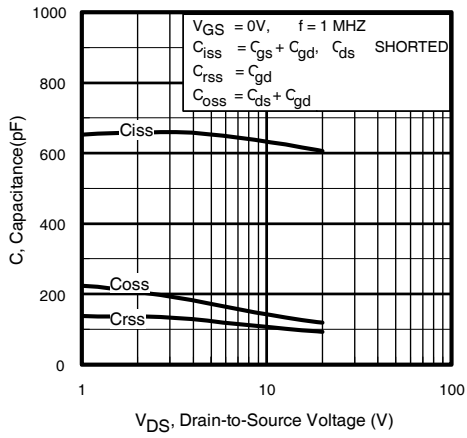


**Fig 3.** Typical Transfer Characteristics

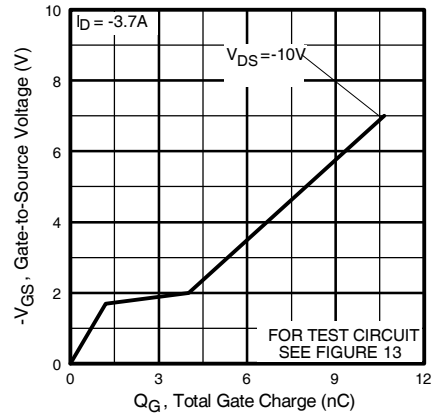


**Fig 4.** Normalized On-Resistance Vs. Temperature

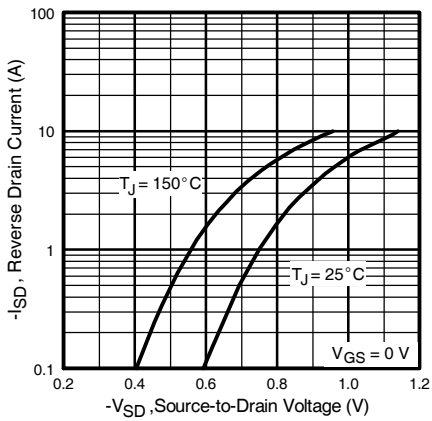
**IRLML6402**



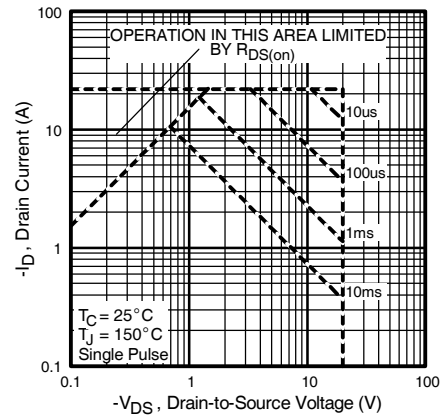
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



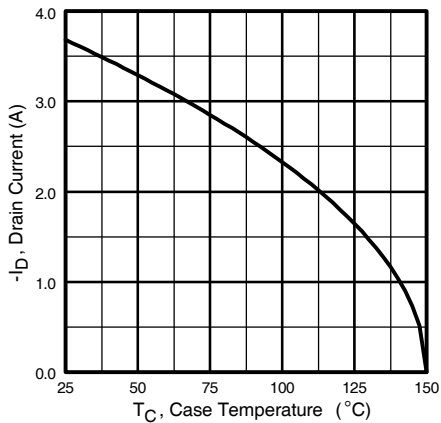
**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



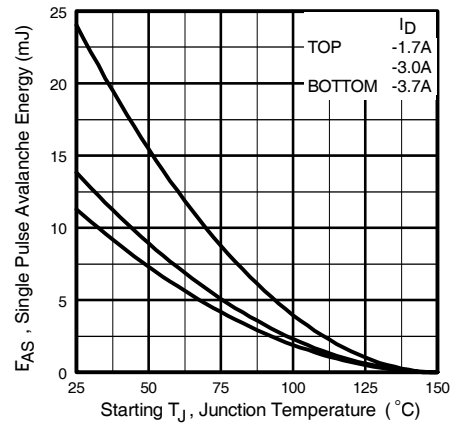
**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 8.** Maximum Safe Operating Area

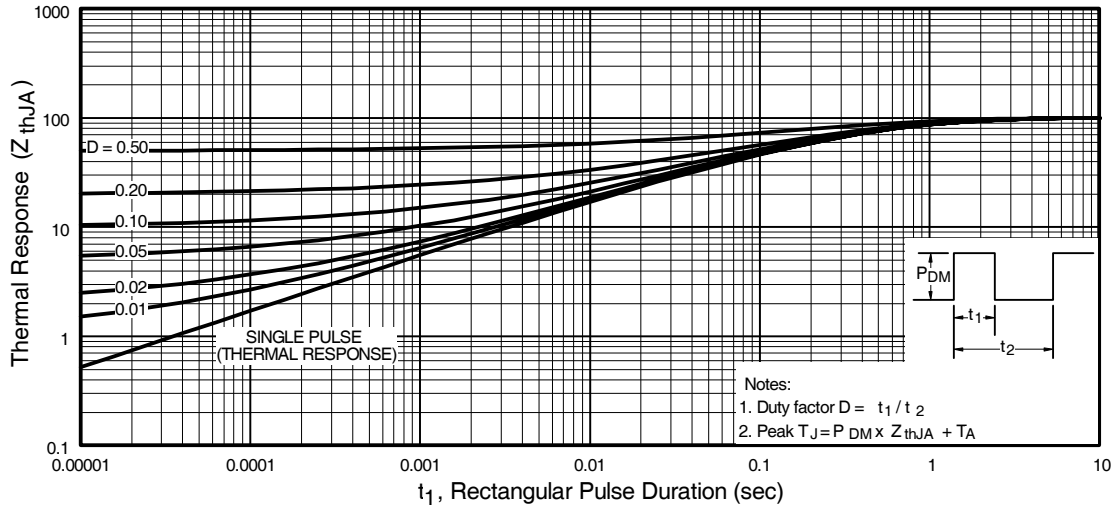


**Fig 9.** Maximum Drain Current Vs. Case Temperature

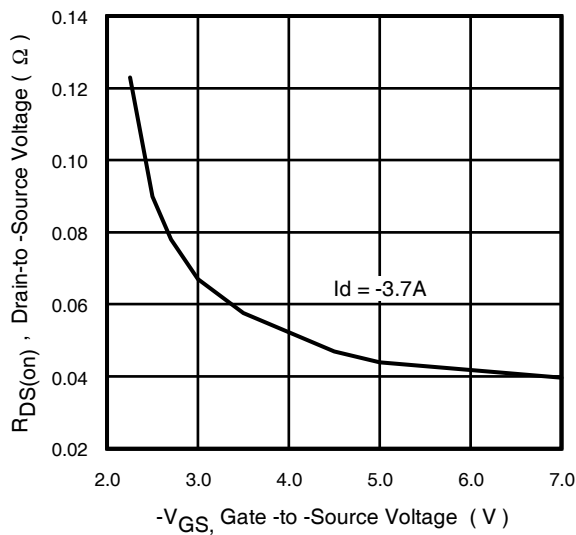


**Fig 10.** Maximum Avalanche Energy Vs. Drain Current

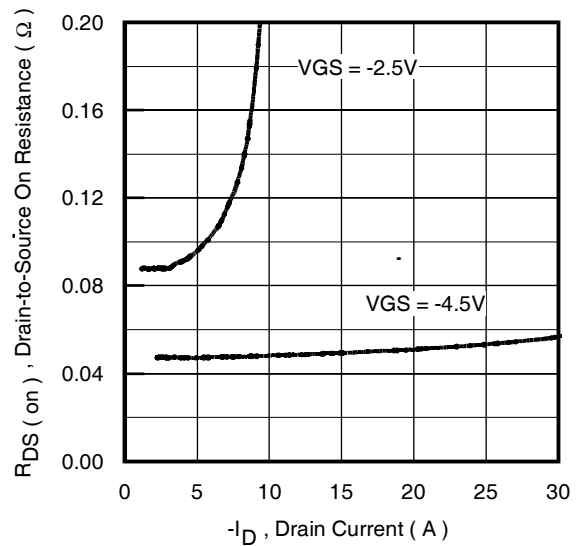
**IRLML6402**



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



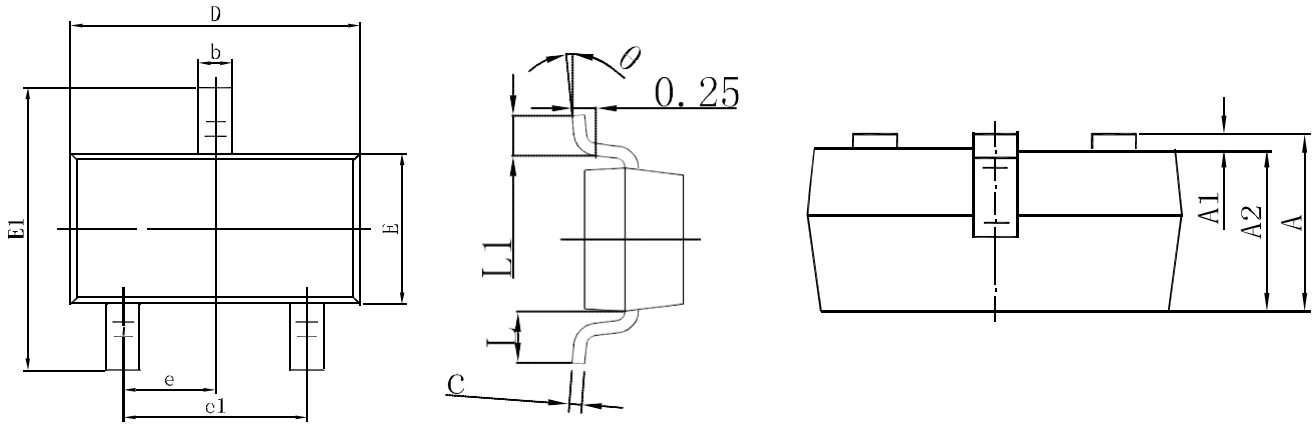
**Fig 12.** Typical On-Resistance Vs. Gate Voltage



**Fig 13.** Typical On-Resistance Vs. Drain Current

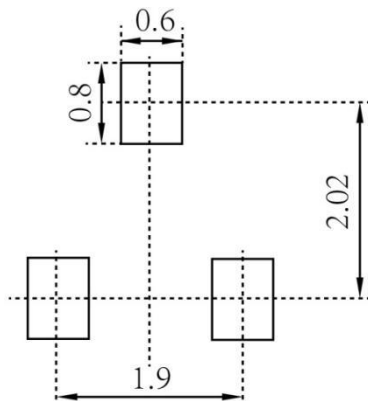
P-Channel Power MOSFET

**SOT-23 Package Outline Dimensions**



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.150 | 0.035                | 0.045 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 0.900                     | 1.050 | 0.035                | 0.041 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.080                     | 0.150 | 0.003                | 0.006 |
| D      | 2.800                     | 3.000 | 0.110                | 0.118 |
| E      | 1.200                     | 1.400 | 0.047                | 0.055 |
| E1     | 2.250                     | 2.550 | 0.089                | 0.100 |
| e      | 0.950 TYP                 |       | 0.037 TYP            |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.550 REF                 |       | 0.022 REF            |       |
| L1     | 0.300                     | 0.500 | 0.012                | 0.020 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

**SOT-23 Suggested Pad Layout**



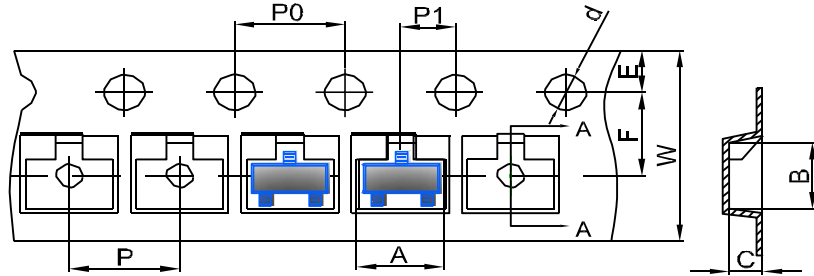
**Note:**

1. Controlling dimension: in millimeters
2. General tolerance: ±0.05mm
3. The pad layout is for reference purposes only

P-Channel Power MOSFET

**SOT-23 Tape and Reel**

**SOT-23 Embossed Carrier Tape**

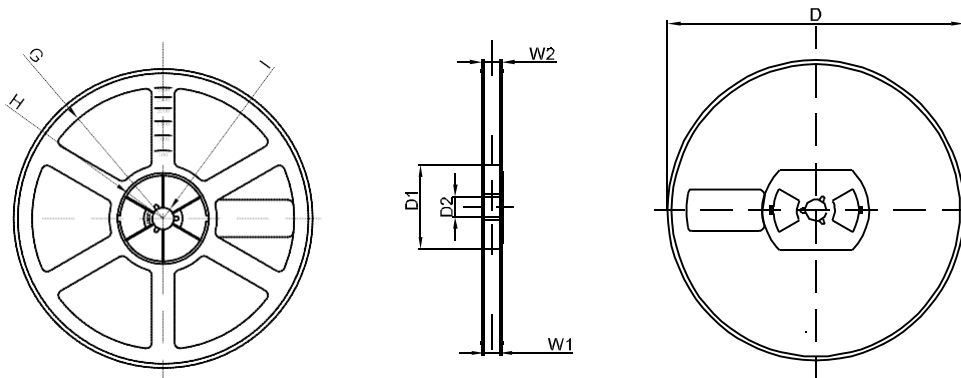


| DIMENSIONS ARE IN MILLIMETER |      |      |      |       |      |      |      |      |      |      |
|------------------------------|------|------|------|-------|------|------|------|------|------|------|
| TYPE                         | A    | B    | C    | d     | E    | F    | P0   | P    | P1   | W    |
| SOT-23                       | 3.15 | 2.77 | 1.22 | Ø1.50 | 1.75 | 3.50 | 4.00 | 4.00 | 2.00 | 8.00 |
| TOLERANCE                    | ±0.1 | ±0.1 | ±0.1 | ±0.1  | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 |

**SOT-23 Tape Leader and Trailer**



**SOT-23 Reel**



| DIMENSIONS ARE IN MILLIMETER |      |       |       |     |        |       |      |       |
|------------------------------|------|-------|-------|-----|--------|-------|------|-------|
| REEL OPTION                  | D    | D1    | D2    | G   | H      | I     | W1   | W2    |
| 7" DIA                       | Ø178 | 54.40 | 13.00 | R78 | R25.60 | R6.50 | 9.50 | 12.30 |
| TOLERANCE                    | ±2   | ±1    | ±1    | ±1  | ±1     | ±1    | ±1   | ±1    |

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